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(54) **Title**: MICROCHIP AND METHOD OF PRODUCING MICROCHIP

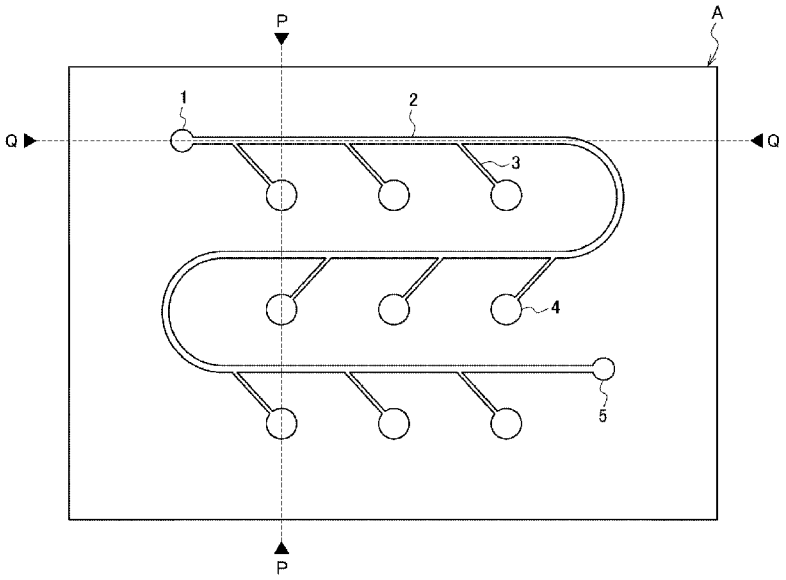


FIG.1

(57) **Abstract**: A microchip is provided. The microchip (A) includes a substrate structure including a fluid channel (2) configured to contain a sample solution, wherein the fluid channel is maintained at a pressure lower than atmospheric pressure prior to injection of the sample solution into the fluid channel.

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